

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Pancham, et al.	§	Case: AMAT/8024/CMP/ECP/RKK
Serial No.: 10/680,325	§	Filed: October 6, 2003
Examiner: Tadesse, Yewebdar, T.	§	Group Art Unit: 1734
Confirmation No.: 5447	§	
Title: APPARATUS TO IMPROVE WAFER TEMPERATURE UNIFORMITY FOR FACE-UP WET PROCESSING	§	

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

RESPONSE TO OFFICE ACTION DATED MARCH 1, 2006

In response to the Office Action dated March 1, 2006, having a shortened statutory period for response set to expire on June 1, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Applicants believe that a one-month extension of \$120.00 is due in connection with this response. This fee has been paid with the submission of this paper using the Patent Electronic Business Center. The Commissioner is authorized to charge any additional fees due for this Response, including additional extension of time or other fees, to Deposit Account No. 20-0782.